TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSIV)

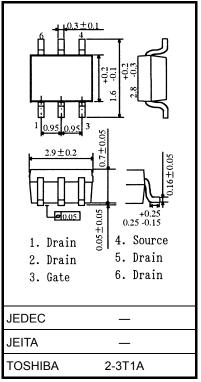
TPC6012

Notebook PC Applications Portable Equipment Applications

- Small footprint due to small and thin package
- Low drain-source ON resistance: R_{DS} (ON) = 20 m Ω (typ.)
- Low leakage current: $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 20 \ V)$
- Enhancement mode: V_{th} = 0.5 to 1.2 V (V_{DS} = 10 V, I_D = 200 μ A)

Absolute Maximum Ratings (Ta = 25°C)

Character	ristics	Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	20	V
Drain-gate voltage (R	_{GS} = 20 kΩ)	V _{DGR}	20	V
Gate-source voltage		V _{GSS}	± 12	V
Drain current	DC (Note 1)	۱ _D	6	А
	Pulse (Note 1)	I _{DP}	24	A
Drain power dissipatio	on (t = 5 s) (Note 2a)	PD	2.2	W
Drain power dissipation (t = 5 s) (Note 2b)		PD	0.7	W
Single pulse avalanch	e energy (Note 3)	E _{AS}	2.3	mJ
Avalanche current		I _{AR}	3	А
Channel temperature		T _{ch}	150	°C
Storage temperature	range	T _{stg}	-55 to 150	°C



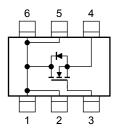
Weight: 0.011 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient $(t = 5 s)$ (Note 2a)	R _{th (ch-a)}	56.8	°C/W
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	R _{th (ch-a)}	178.5	°C/W

Circuit Configuration



Note: (Note 1), (Note 2), (Note 3): See other pages.

This transistor is an electrostatic-sensitive device. Please handle with caution.

Unit: mm

Electrical Characteristics (Ta = 25°C)

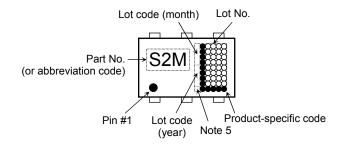
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS}=\pm12~V,V_{DS}=0~V$	_	- <u>±</u> 100		nA
Drain cut-off curr	ent	I _{DSS}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	10		10	μΑ
Drain-source breakdown voltage		V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	20			v
		V (BR) DSX	$I_D = 10 \text{ mA}, V_{GS} = -12 \text{ V}$	8			
Gate threshold voltage		V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 200 \mu\text{A}$	0.5	_	1.2	V
Drain-source ON resistance		Pro (ou)	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 3 \text{ A}$	_	25	38	mΩ
		R _{DS} (ON)	$V_{GS}=4.5~V,~I_D=3~A$	_	15	20	
Input capacitance		C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	630	_	pF
Reverse transfer capacitance		C _{rss}			150		
Output capacitance		C _{oss}			180		
Switching time	Rise time	tr	$V_{GS} = \begin{bmatrix} 5 \\ 0 \\ V \end{bmatrix} \begin{bmatrix} I_D = 3 \\ 0 \\ V_{OUT} \end{bmatrix}$	_	5	_	- ns
	Turn-on time	t _{on}		_	10	_	
	Fall time	t _f	,,, , , ,	_	10	_	
	Turn-off time	t _{off}	Duty \leq 1%, t _w = 10 µs	_	24	_	
Total gate charge (gate-source plus gate-drain)		Qg	V _{DD} ≈ 16 V, V _{GS} = 5 V,	_	9		nC
Gate-source charge 1		Q _{gs 1}	$I_D = 6 A$		1.8		
Gate-drain ("miller") charge		Q _{gd}		_	3.4		

Source-Drain Ratings and Characteristics (Ta = 25° C)

Charact	teristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	—	_	_	24	А
Forward voltage	(diode)	V _{DSF}	$I_{DR} = 6 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$			-1.2	V

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Marking (Note 5)



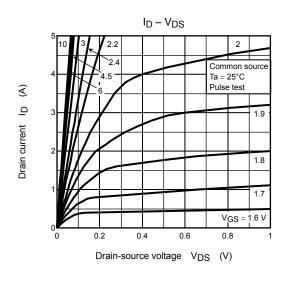
- Note 1: Ensure that the channel temperature does not exceed 150°C.
- Note 2: (a) Device mounted on a glass-epoxy board (a) (t = 5 s) (b) Device mounted on a glass-epoxy board (b) (t = 5 s)

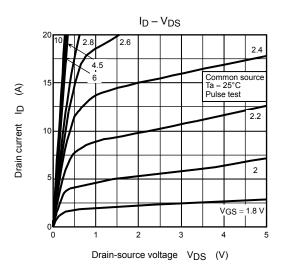


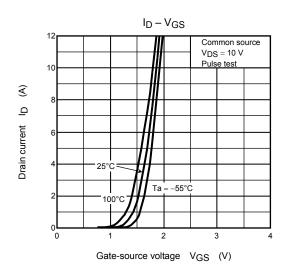
- Note 3: V_{DD} = 16 V, T_{ch} = 25°C (initial), L = 0.2 mH, R_G = 25 Ω , I_{AR} = 3 A
- Note 4: on lower left of the marking indicates Pin 1.
- Note 5: A dot marking for identifying the indication of product Labels. Without a dot: [[Pb]]/INCLUDES > MCV With a dot: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

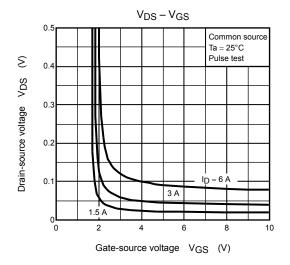
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

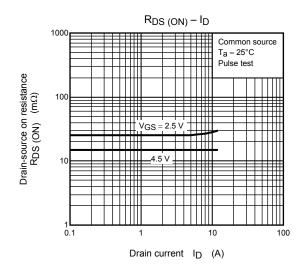
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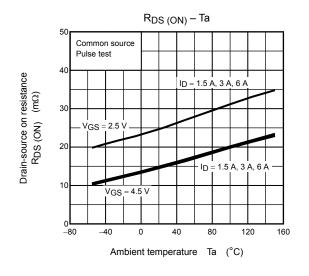


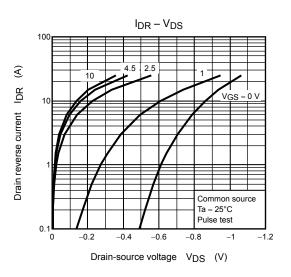


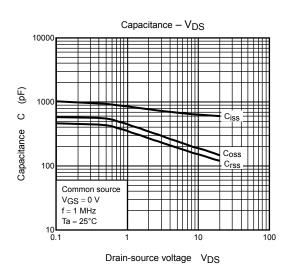


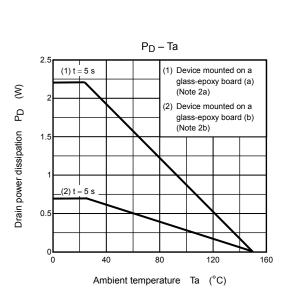


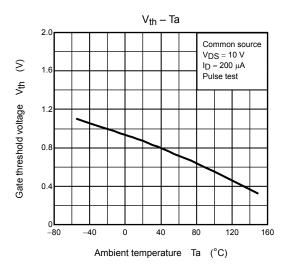
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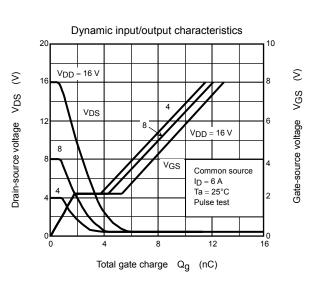


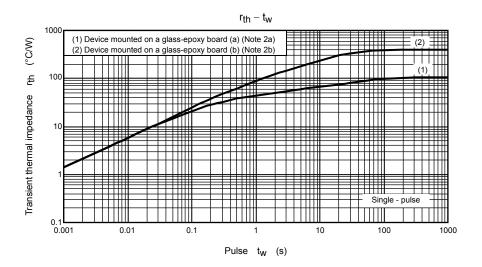


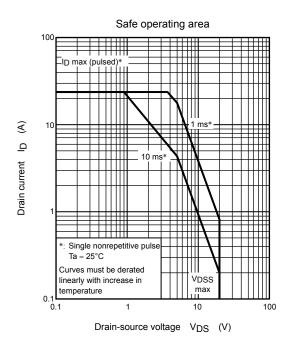












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